

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

Symbol	Parameter		Value	Unit
V_{PP}	Peak pulse voltage ⁽¹⁾	ESD discharge IEC 61000-4-2, level 4		
		Contact discharge on D+/D- pins	10	kV
		Contact discharge on V_{BUS} and I_D pins	20	
		Air discharge on all pins	30	
P_{PP}	Peak pulse power (8/20 μ s) on V_{BUS}		150	W
I_{PP}	Peak pulse current (8/20 μ s) on V_{BUS}		4.8	A
T_{op}	Operating temperature		-30 to +85	$^{\circ}\text{C}$
T_j	Maximum junction temperature		125	$^{\circ}\text{C}$
T_{stg}	Storage temperature range		- 55 to +150	$^{\circ}\text{C}$

1. Measurements done on IEC 61000-4-2 test bench. For further details see Application note AN3353.

Figure 2. Electrical characteristics - definitions

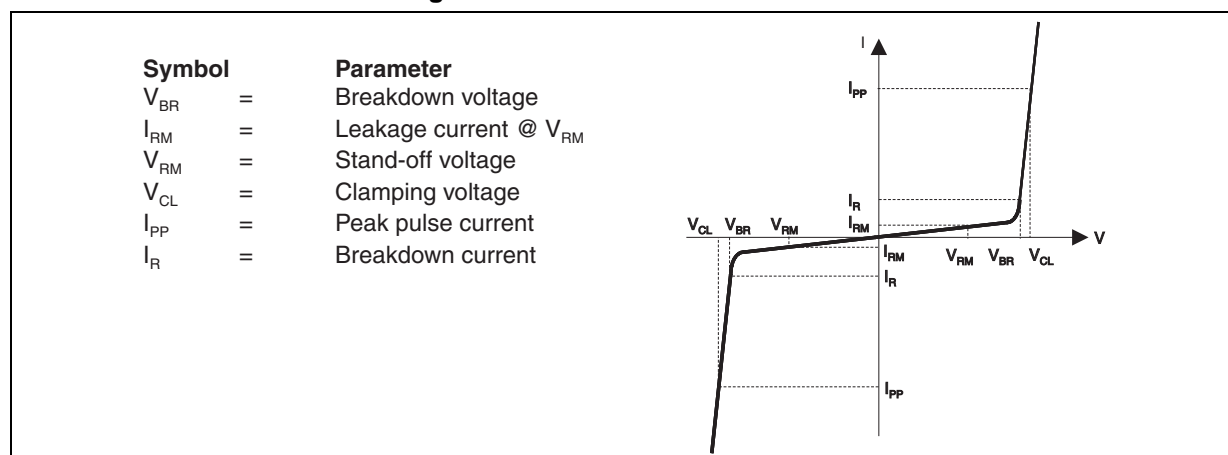


Table 2. Electrical characteristics (values, $T_{amb} = 25\text{ }^{\circ}\text{C}$)

Symbol	Test conditions	Min.	Typ.	Max.	Unit
Data Lines					
V_{BR}	$I_R = 1\text{ mA}$	6			V
I_{RM}	$V_{RM} = 5.5\text{ V per line}$			100	nA
R_{DC}	DC serial resistance on data line		3	4	Ω
V_{BUS}					
V_{BR}	$I_R = 1\text{ mA}$	15	16.5	18	V
I_{RM}	$V_{RM} = 12\text{ V}$			50	nA
V_{CL}	Clamping voltage. $I_{PP} = 1\text{ A}$, $t_p = 8/20\text{ }\mu\text{s}$			20	V
V_{CL}	Clamping voltage. $I_{PP} = 2.5\text{ A}$, $t_p = 8/20\text{ }\mu\text{s}$			24	V
I_D					
V_{BR}	$I_R = 1\text{ mA}$	6			V
I_{RM}	$V_{RM} = 1.5\text{ V per line}$			100	nA

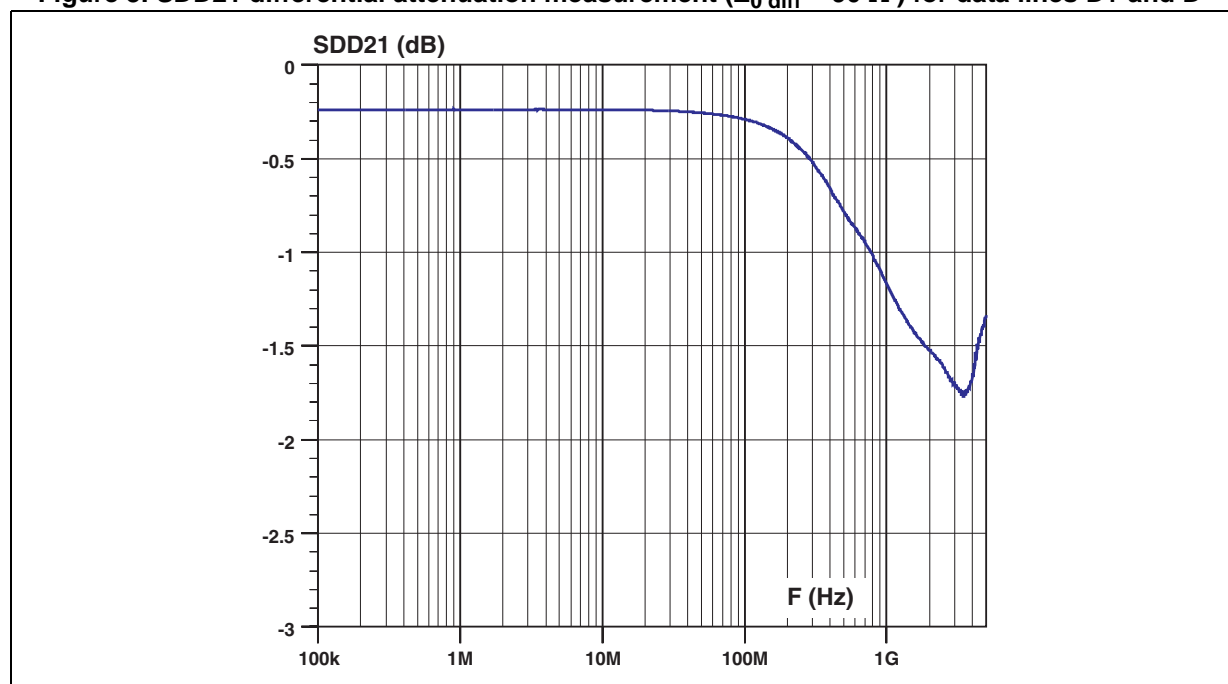
Figure 3. SDD21 differential attenuation measurement ($Z_{0\text{ diff}} = 90\text{ }\Omega$) for data lines D+ and D-

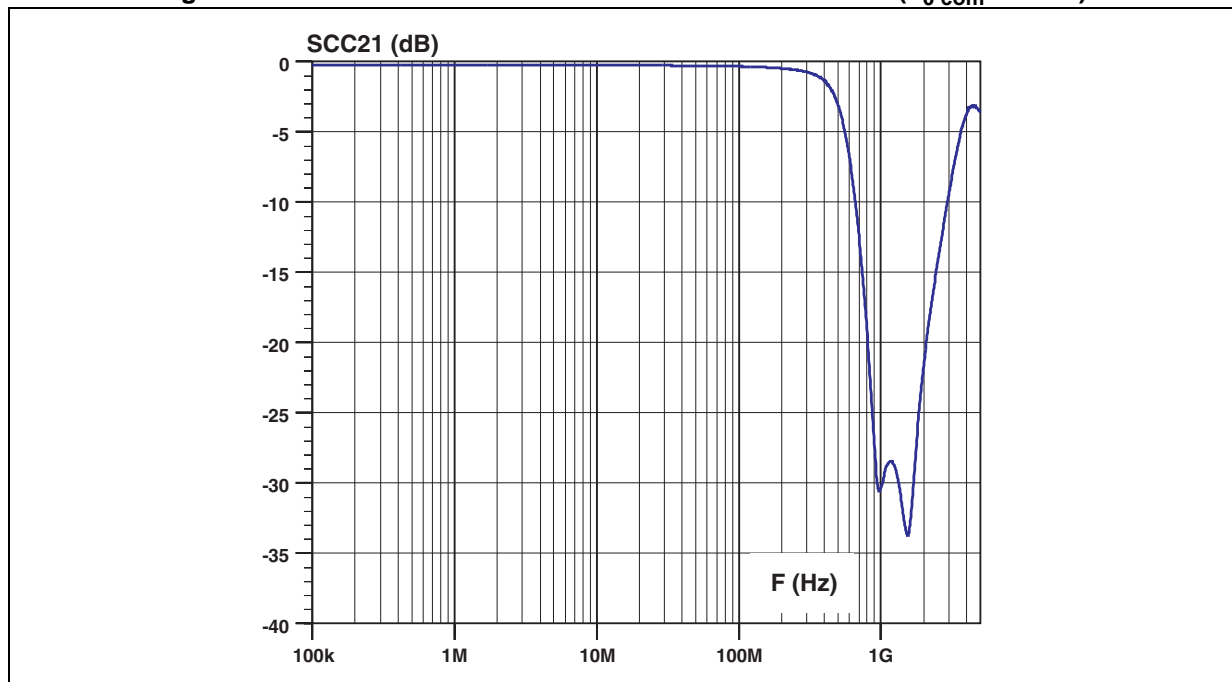
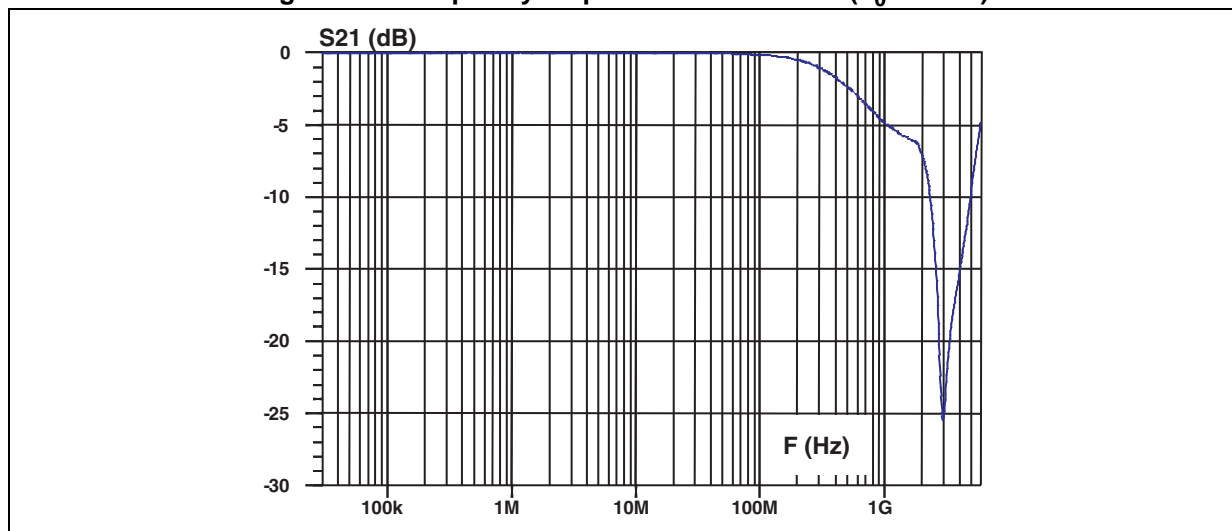
Figure 4. SCC21 common mode attenuation measurement ($Z_{0\text{ com}} = 45\ \Omega$)Figure 5. ID frequency response measurement ($Z_0 = 75\ \Omega$)

Figure 6. ESD test conditions

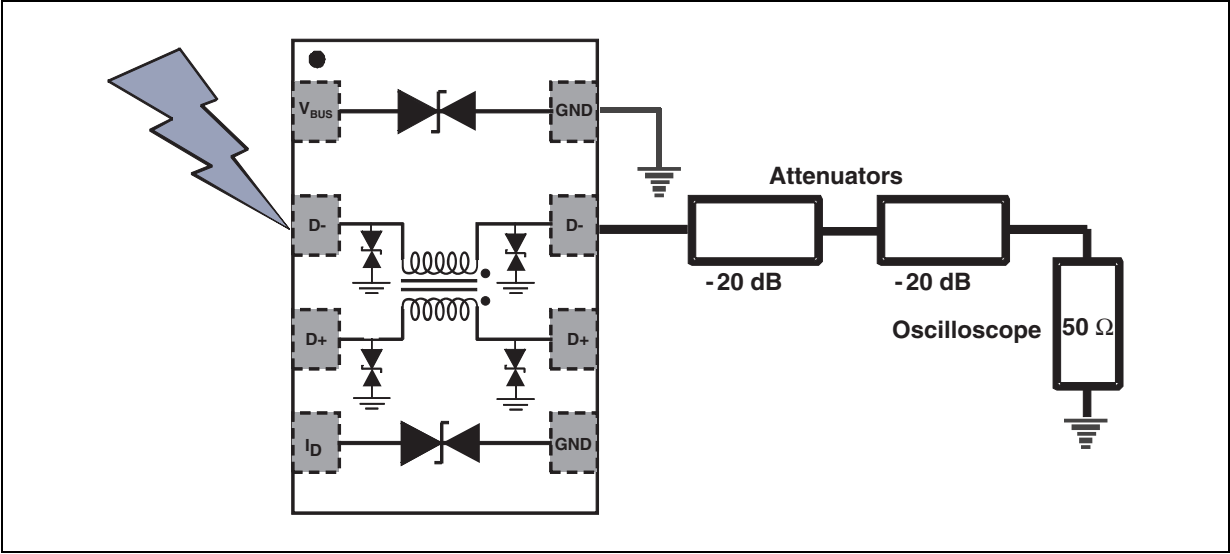


Figure 7. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on V_{BUS}

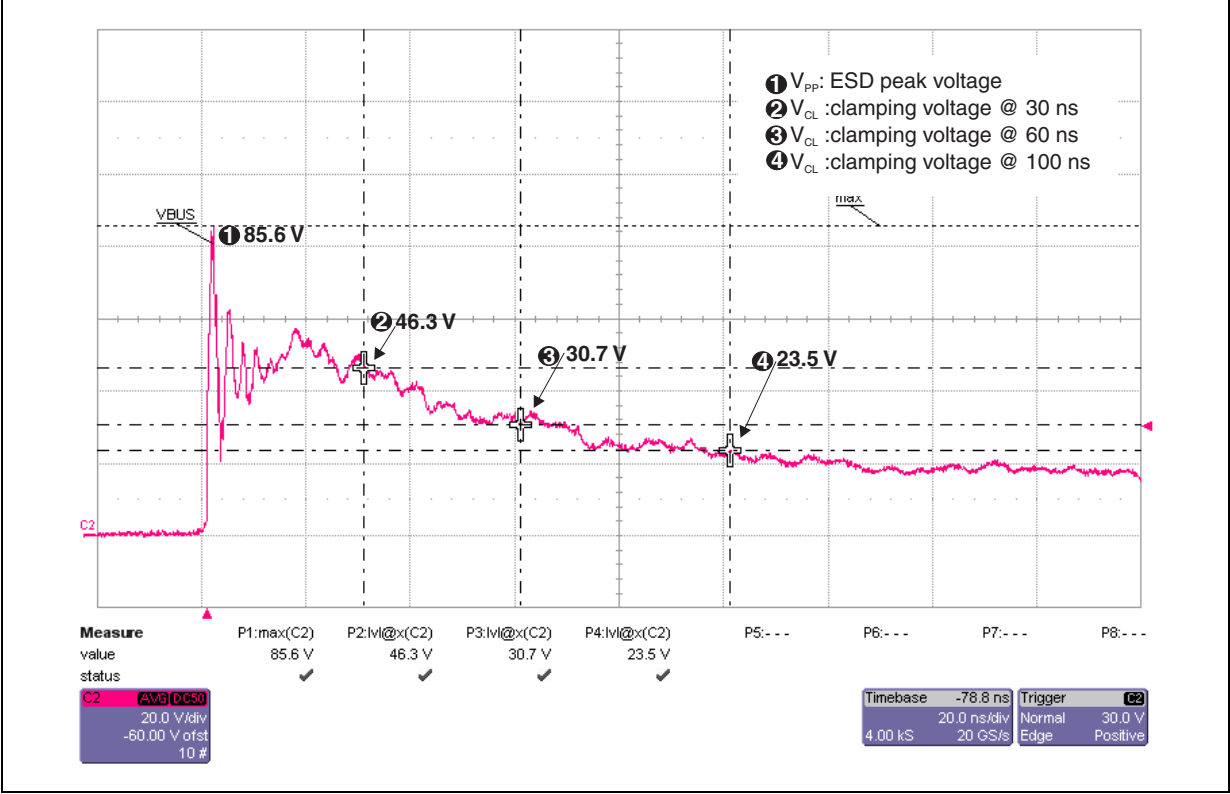


Figure 8. ESD response to IEC 61000-4-2 (-8 kV contact discharge) on V_{BUS}

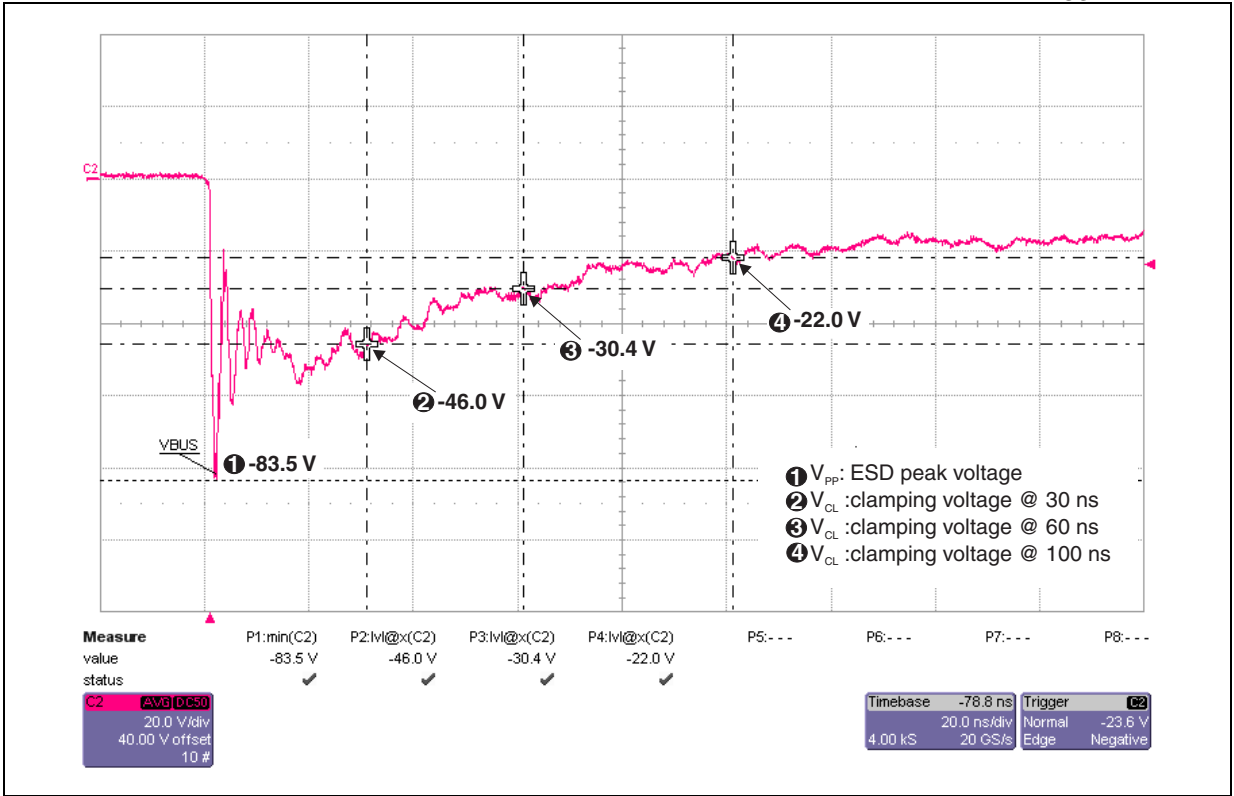


Figure 9. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on I_D

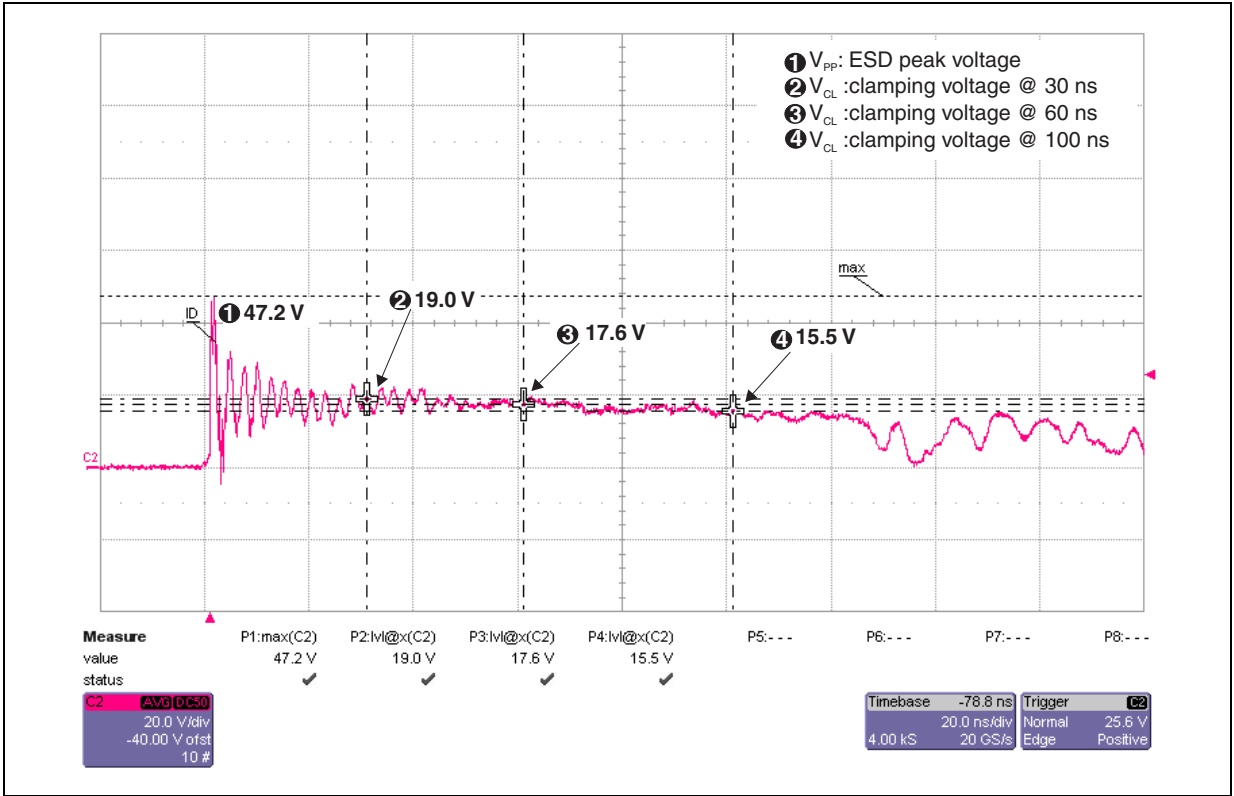


Figure 10. ESD response to IEC 61000-4-2 (-8 kV contact discharge) on I_D

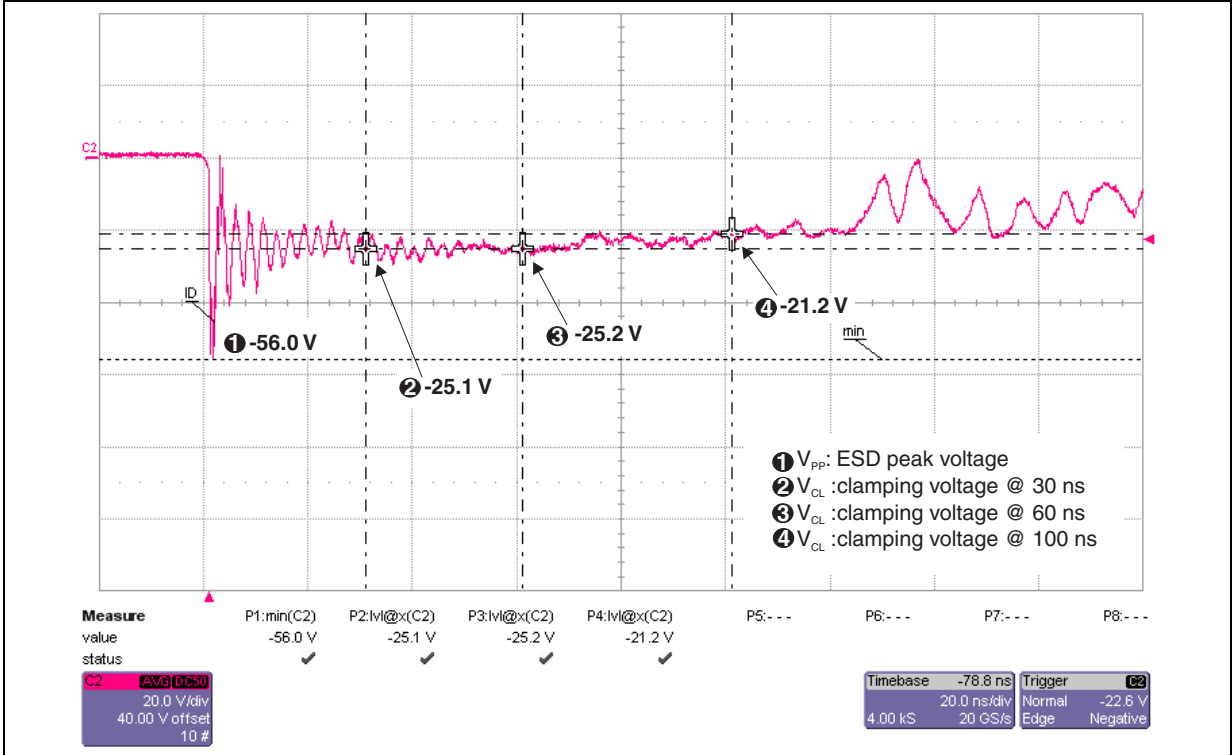


Figure 11. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on differential lane

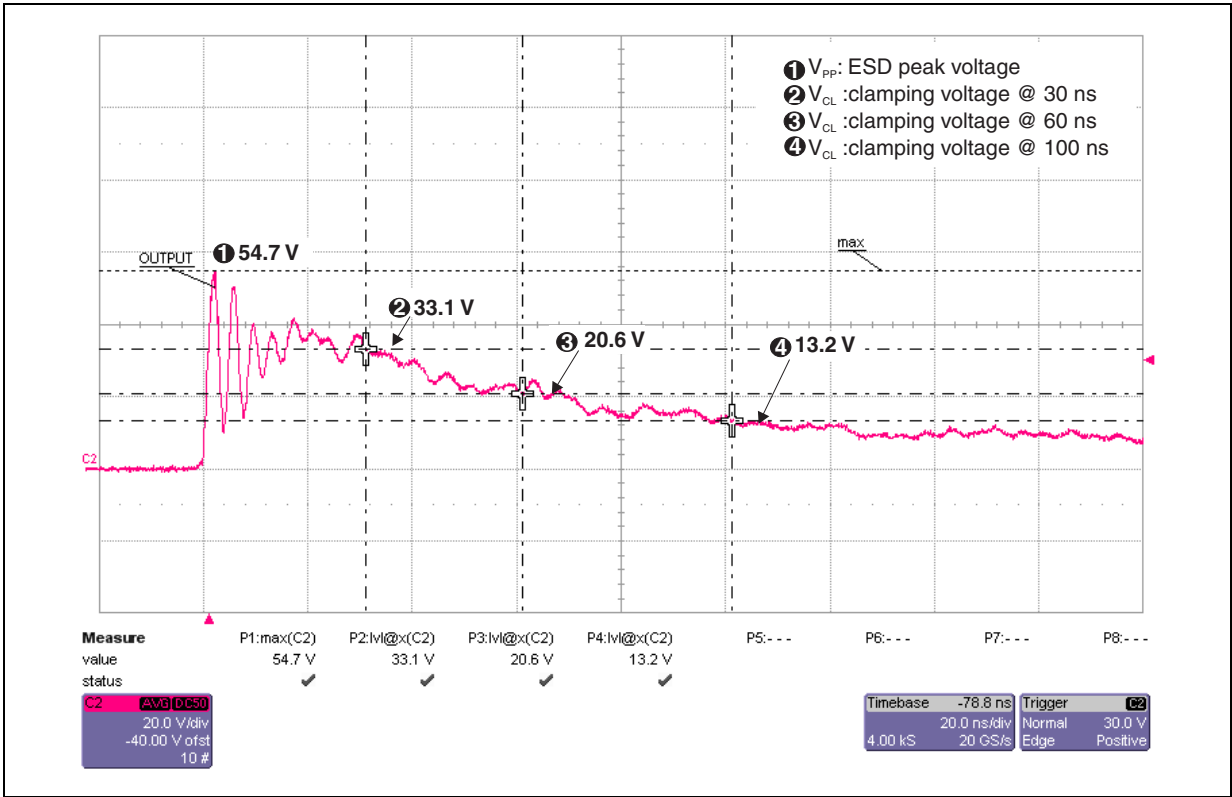


Figure 12. ESD response to IEC 61000-4-2 (-8 kV contact discharge) on differential lane

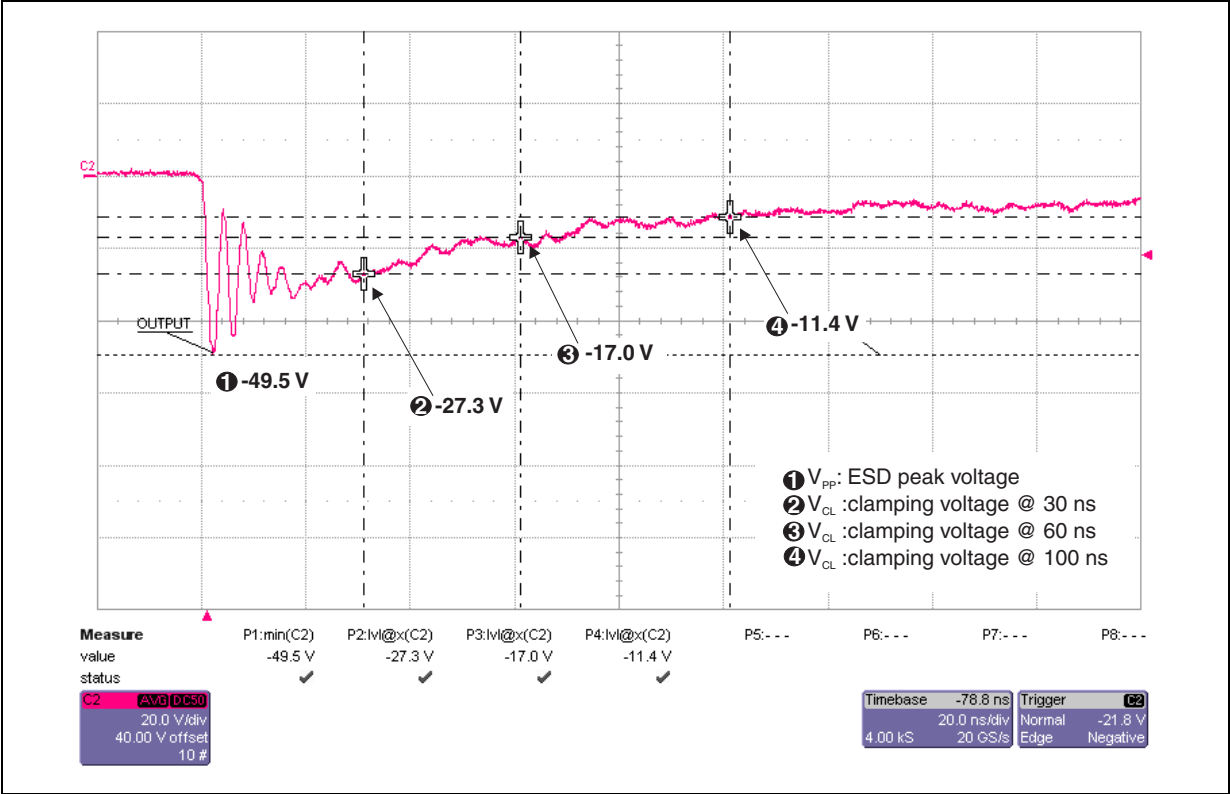


Figure 13. Eye diagram (loaded by $Z_{diff} = 90 \Omega$) with USB2.0 [mask 1] board only

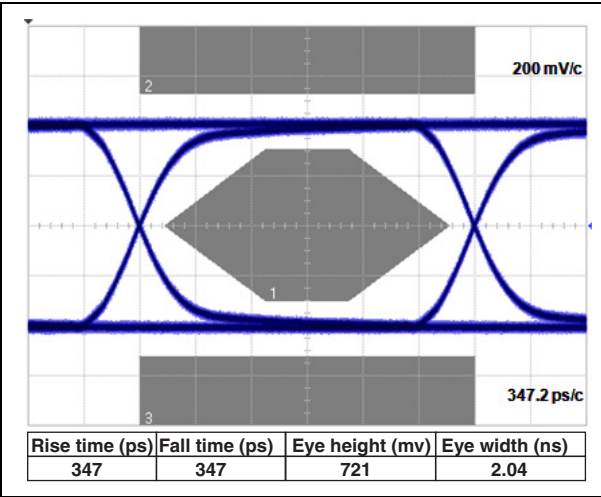


Figure 14. Eye diagram (loaded by $Z_{diff} = 90 \Omega$) with USB2.0 [mask 1] board with ECM02-4CMX8

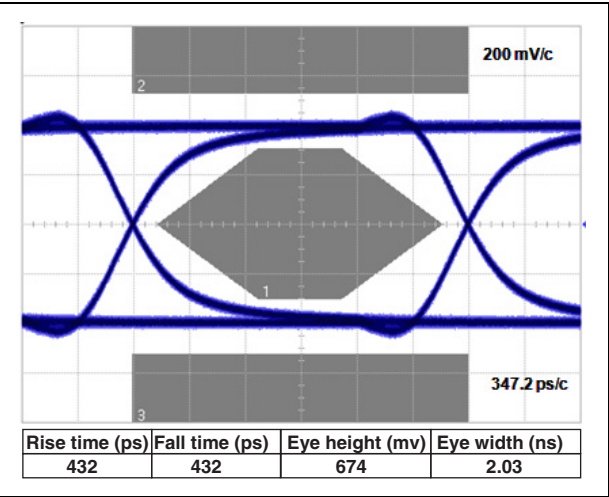


Figure 15. TDR measurement (loaded by $Z_{diff} = 90 \Omega$), rise time 400 ps

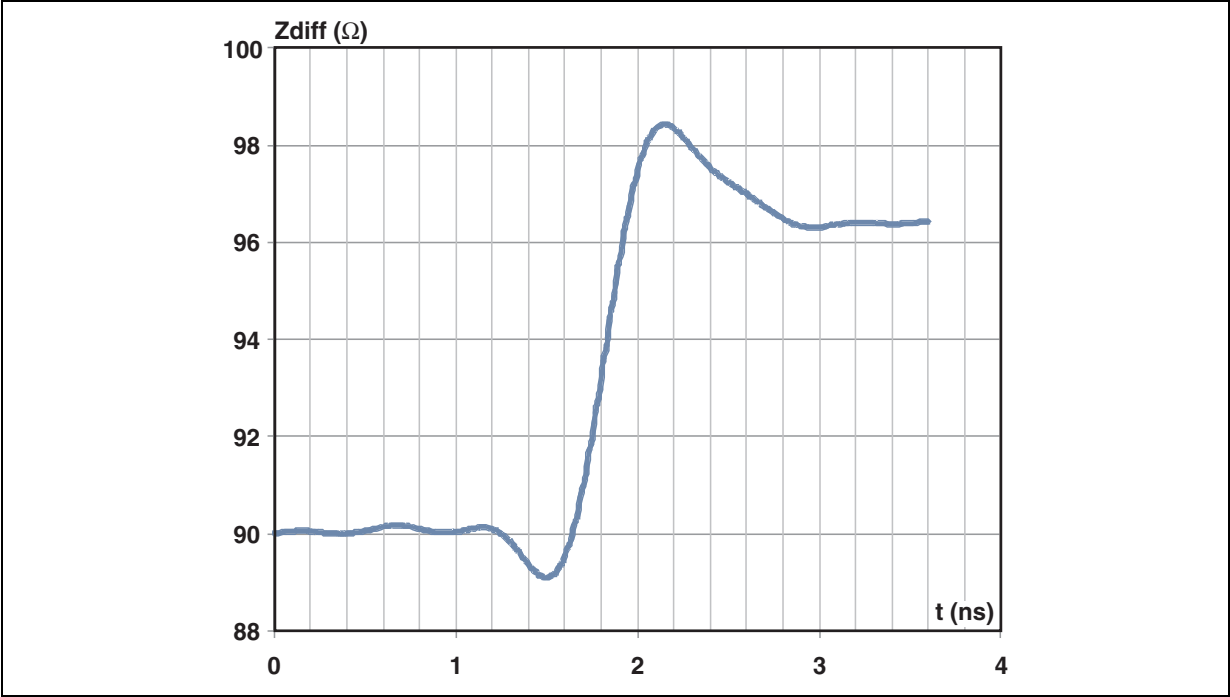


Figure 16. HS sync

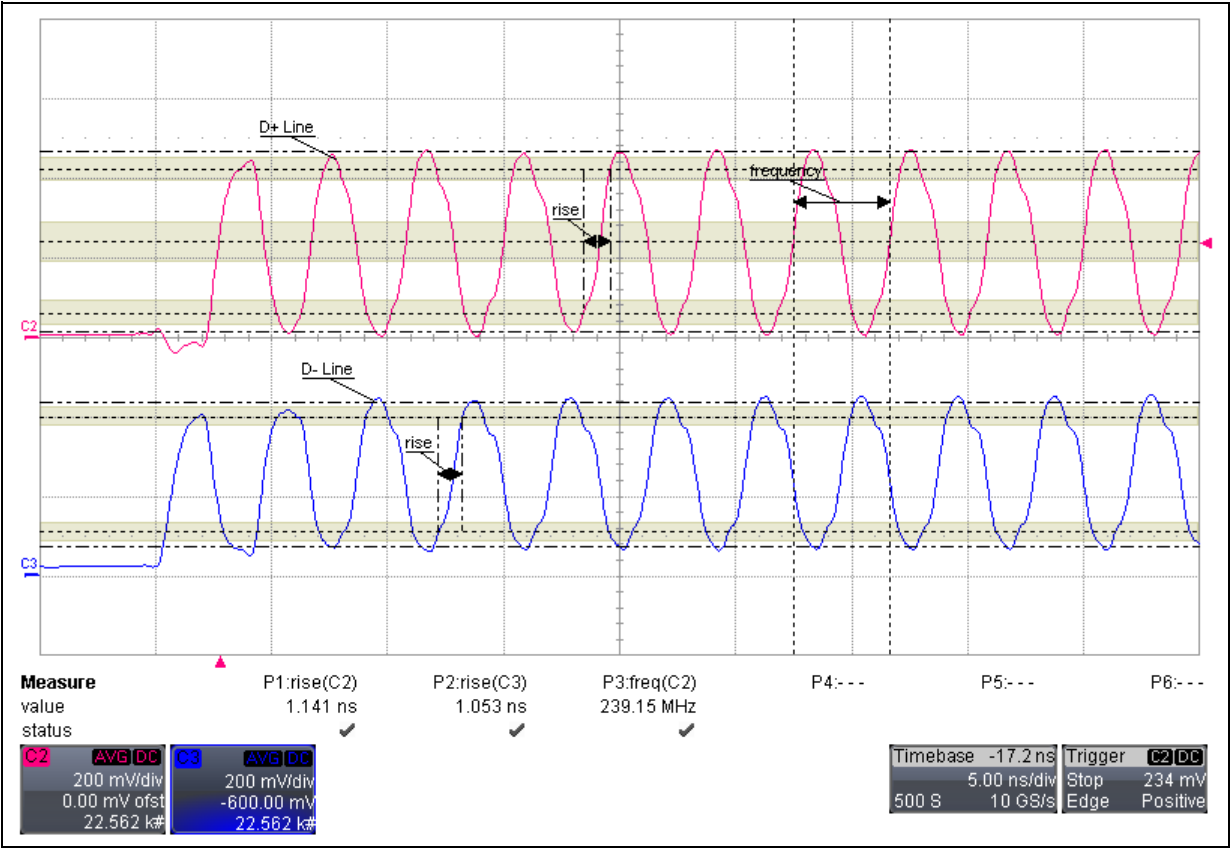


Figure 17. Total harmonic distortion on differential lanes

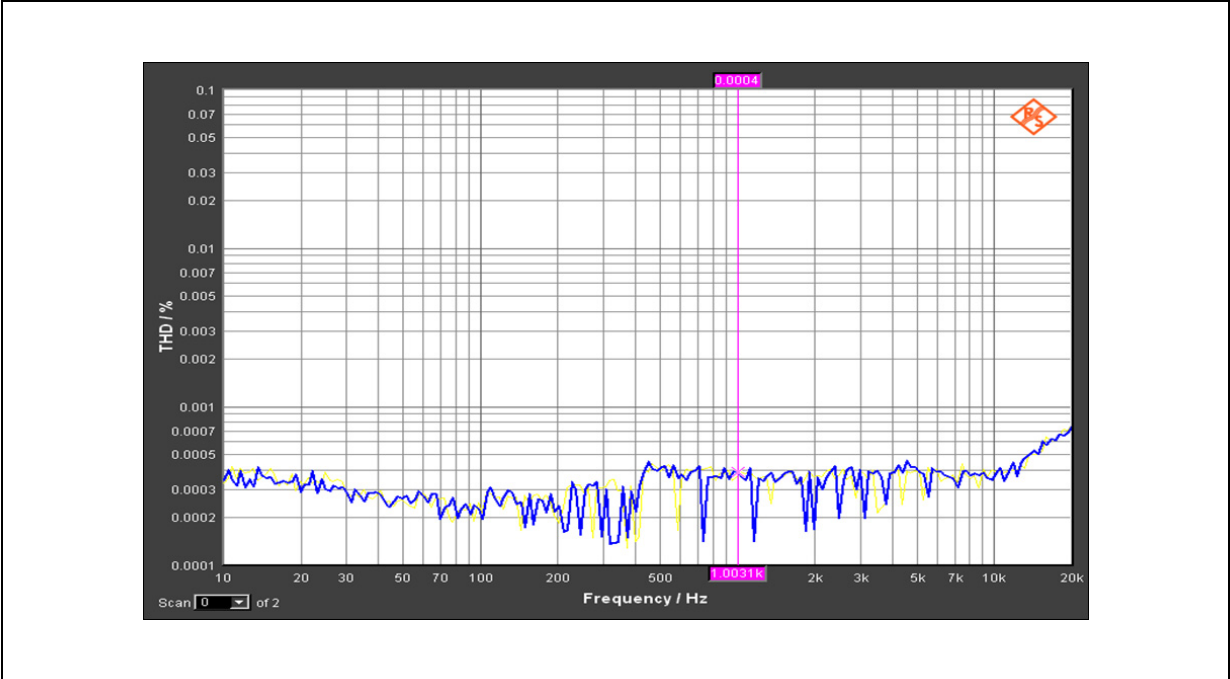
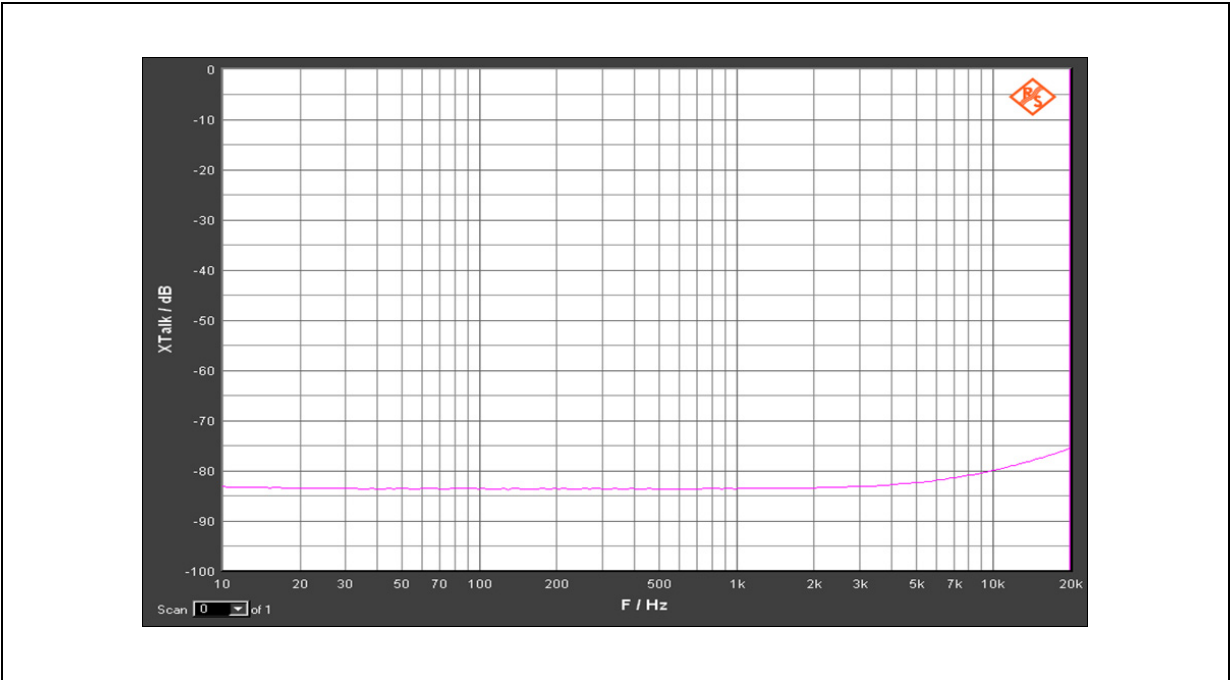
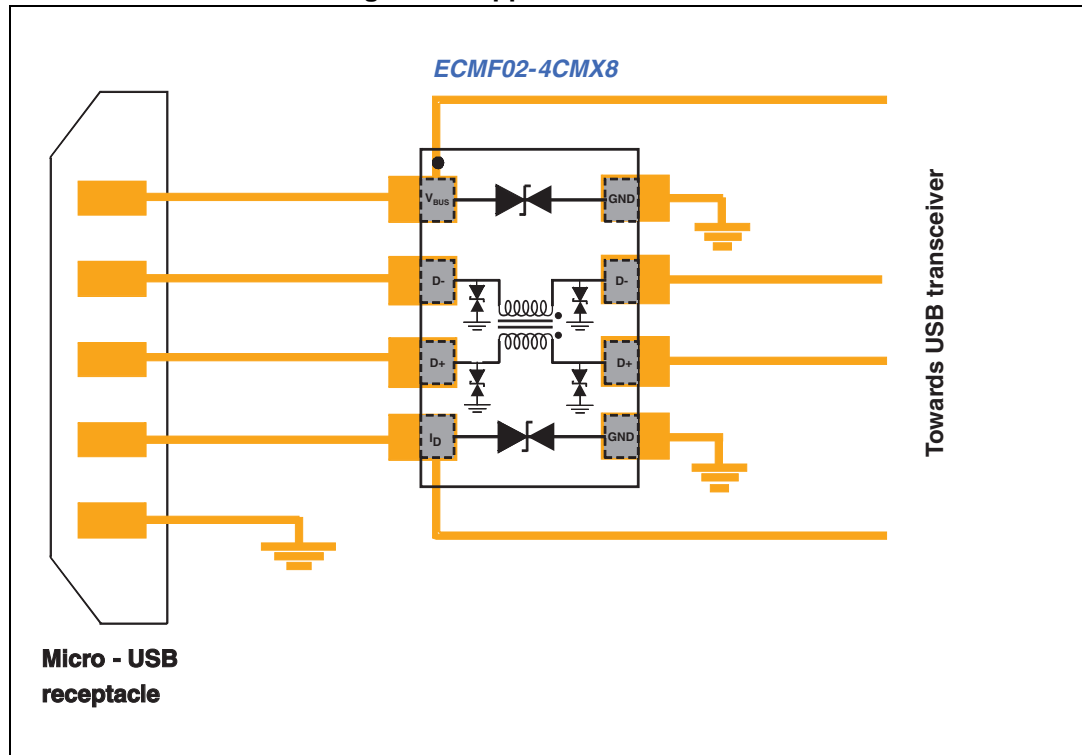


Figure 18. Crosstalk on differential lanes



2 Application schematic

Figure 19. Application schematic



3 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Figure 20. Micro QFN-8L dimension definitions

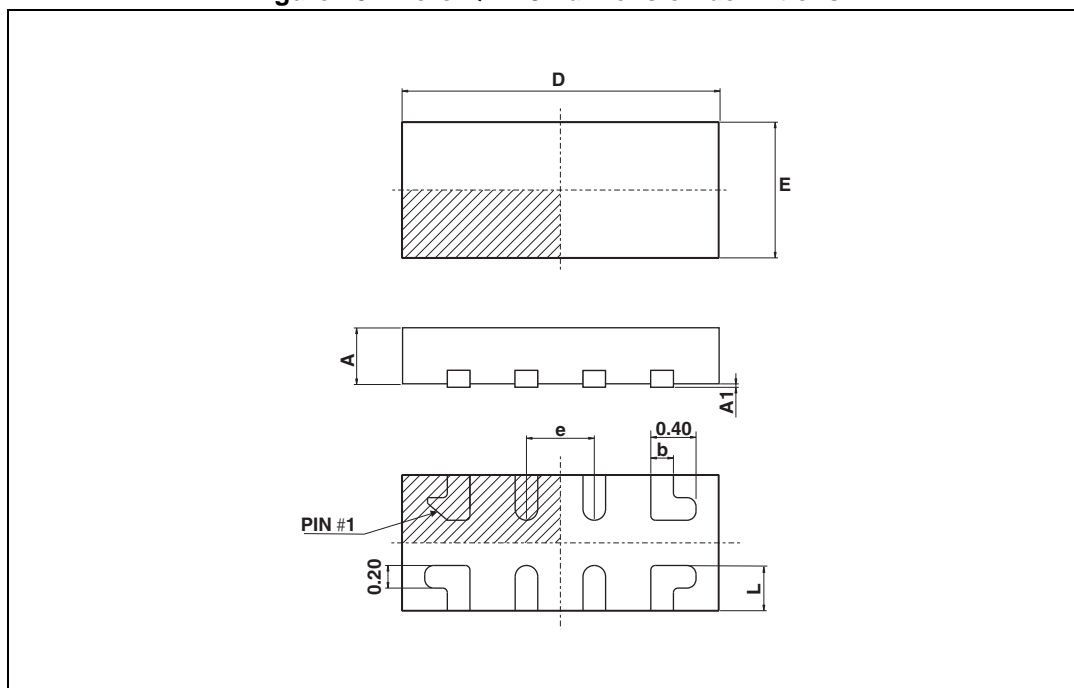


Table 3. Micro QFN-8L dimension values

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.45	0.50	0.55	0.018	0.020	0.022
A1	0.00	0.02	0.05	0.00	0.0008	0.002
b	0.15	0.20	0.25	0.006	0.008	0.010
D	2.45	2.50	2.55	0.096	0.098	0.100
E	1.15	1.20	1.25	0.045	0.047	0.049
e	0.45	0.50	0.55	0.018	0.020	0.022
L	0.30	0.40	0.50	0.012	0.016	0.020

Figure 21. Footprint

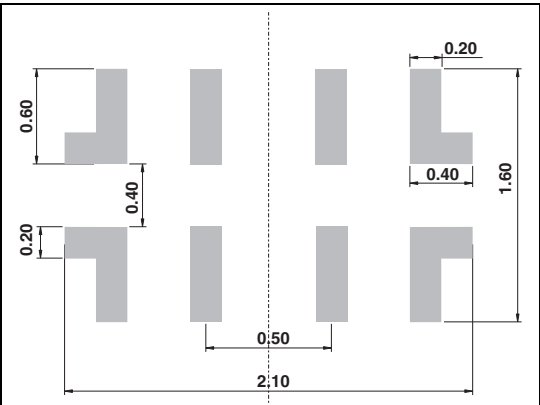


Figure 22. Marking

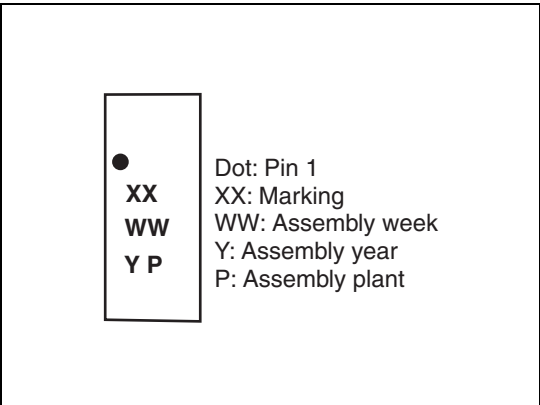
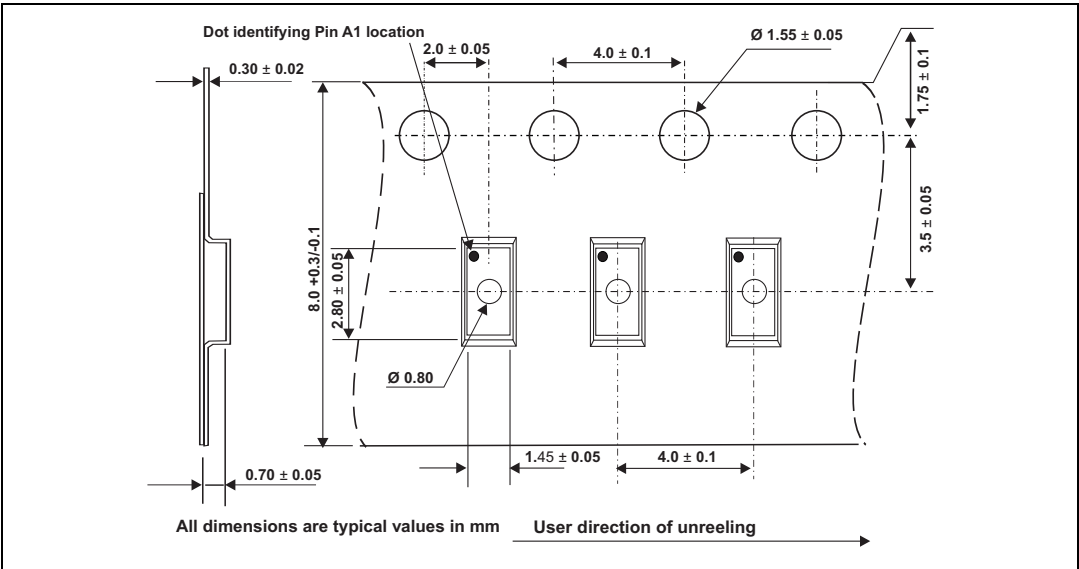


Figure 23. Tape and reel specifications



Note: More packing information is available in the application notes: AN1751: “EMI Filters: Recommendations and measurements”

4 Ordering information

Figure 24. Ordering information scheme

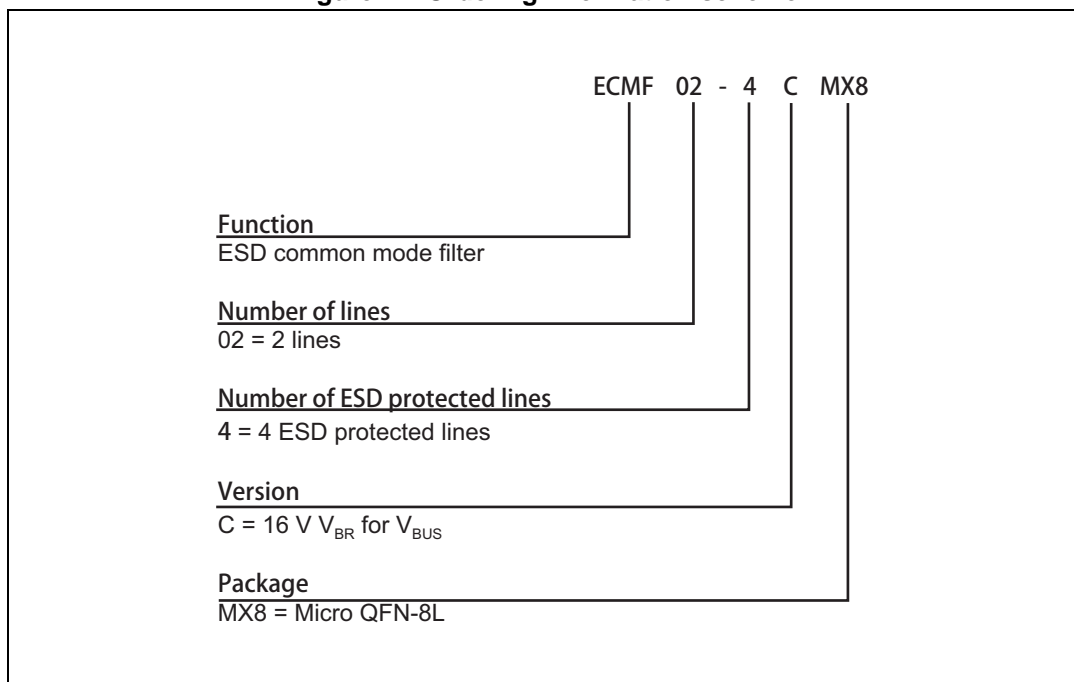


Table 4. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
ECMF02-4CMX8	KG	Micro QFN-8L	3,7 mg	3000	Tape and reel

For the latest information on available order codes see the product pages on: www.st.com.

5 Revision history

Table 5. Document revision history

Date	Revision	Changes
19-Sep-2012	1	Initial release.
27-May-2014	2	Updated Figure 23 , Figure 24 and reformatted the document.

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